

5000W, 16V - 100V Surface Mount Transient Voltage Suppressor

FEATURES

- AEC-Q101 qualified
- 5000W peak pulse power capability at 10/1000 μ s waveform
- Ideal for automated placement
- Photo glass passivated junction
- Excellent clamping capability
- Fast response time: Typically less than 1.0ps
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- I/O interface
- AC/DC power supply

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.300g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
V_{WM}	16 - 100	V
V_{BR} (uni-directional)	17.8 - 123	V
P_{PPSM}	5000	W
$T_{J\ MAX}$	175	°C
Package	DO-214AB (SMC)	
Configuration	Stacked die	



DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Non-repetitive peak impulse power dissipation with 10/1000 μ s waveform ⁽¹⁾	P_{PK}	5000	W
Steady state power dissipation at $T_L = 75^\circ\text{C}$ ⁽²⁾	P_D	6.25	W
Forward Voltage @ $I_F = 100\text{A}$ for Uni-directional only ⁽³⁾	V_F	5	V
Junction temperature	T_J	-55 to +175	°C
Storage temperature	T_{STG}	-55 to +175	°C

Notes:

1. Non-repetitive current pulse per Fig.3 and derated above $T_A = 25^\circ\text{C}$ Per Fig.1
2. Units mounted on PCB (16mm x 16mm Cu pad test board)
3. Pulse test with PW = 0.3ms

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	16	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	61	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	17	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Part number	Marking code	Breakdown voltage $V_{BR}@I_T$ (V) (Note 1)		Test current I_T (mA)	Working stand-off voltage V_{WM} (V)	Maximum blocking leakage current $I_{B@V_{WM}}$ (μA) (Note 1)	Maximum peak impulse current I_{PP} (A)	Maximum clamping voltage $V_C@I_{PP}$ (V)	Maximum Temp. coefficient of V_{BR} $\alpha V_{BR}@I_T$ (mV/ $^\circ\text{C}$)
		Min	Max						
5.0SMDJ16AH	5PET	17.8	19.7	1	16	50	193	26.0	0.096
5.0SMDJ17AH	5PEU	18.9	20.9	1	17	20	181	27.6	0.097
5.0SMDJ18AH	5PEV	20.0	22.1	1	18	10	172	29.2	0.098
5.0SMDJ20AH	5PEW	22.2	24.5	1	20	5	155	32.4	0.099
5.0SMDJ22AH	5PEX	24.4	26.9	1	22	5	141	35.5	0.100
5.0SMDJ24AH	5PEZ	26.7	29.5	1	24	2	129	38.9	0.101
5.0SMDJ26AH	5PFE	28.9	31.9	1	26	2	119	42.1	0.101
5.0SMDJ28AH	5PFG	31.1	34.4	1	28	2	110	45.4	0.102
5.0SMDJ30AH	5PFK	33.3	36.8	1	30	2	103	48.4	0.103
5.0SMDJ33AH	5PFM	36.7	40.6	1	33	2	93.9	53.3	0.104
5.0SMDJ36AH	5PFP	40.0	44.2	1	36	2	86.1	58.1	0.104
5.0SMDJ40AH	5PFR	44.4	49.1	1	40	2	77.6	64.5	0.105
5.0SMDJ43AH	5PFT	47.8	52.8	1	43	2	72.1	69.4	0.105
5.0SMDJ45AH	5PFV	50.0	55.3	1	45	2	68.8	72.7	0.106
5.0SMDJ48AH	5PFX	53.3	58.9	1	48	2	64.7	77.4	0.106
5.0SMDJ51AH	5PFZ	56.7	62.7	1	51	2	60.7	82.4	0.107
5.0SMDJ54AH	5PGE	60.0	66.3	1	54	2	57.5	87.1	0.107
5.0SMDJ58AH	5PGG	64.4	71.2	1	58	2	53.5	93.6	0.107
5.0SMDJ60AH	5PGK	66.7	73.7	1	60	2	51.7	96.8	0.108
5.0SMDJ64AH	5PGM	71.1	78.6	1	64	2	48.6	103	0.108
5.0SMDJ70AH	5PGP	77.8	86.0	1	70	2	44.3	113	0.108
5.0SMDJ75AH	5PGR	83.3	92.1	1	75	2	41.4	121	0.108
5.0SMDJ78AH	5PGT	86.7	95.8	1	78	2	39.7	126	0.108
5.0SMDJ85AH	5PGV	94.4	104	1	85	2	36.5	137	0.110
5.0SMDJ90AH	5PGX	100	111	1	90	2	34.3	146	0.110
5.0SMDJ100AH	5PGZ	111	123	1	100	2	30.9	162	0.110

Note:

1. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
5.0SMDJxH	DO-214AB (SMC)	3,000 / Tape & Reel

Notes:

1. "x" defines voltage from 16V(5.0SMDJ16AH) to 100V(5.0SMDJ100AH)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Pulse Power or Current vs. Initial Junction

Temperature

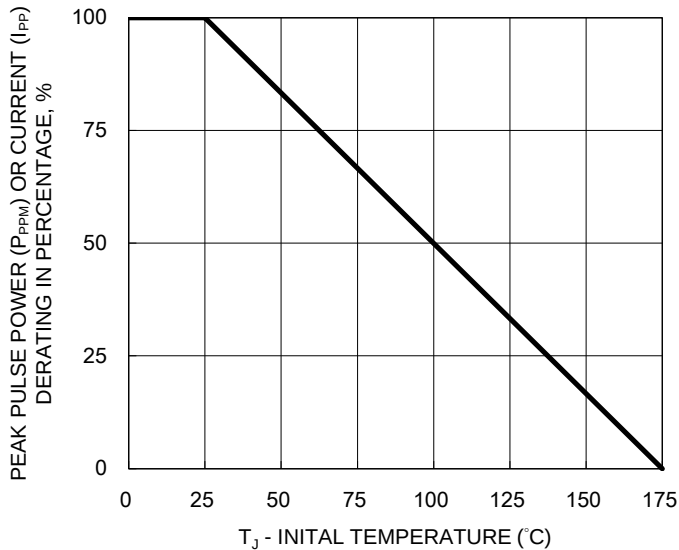


Fig.2 Power Derating Curve

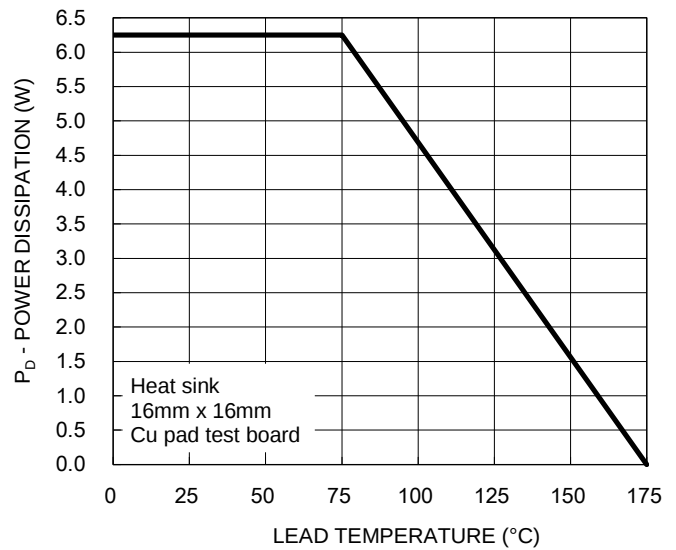


Fig.3 Pulse Waveform

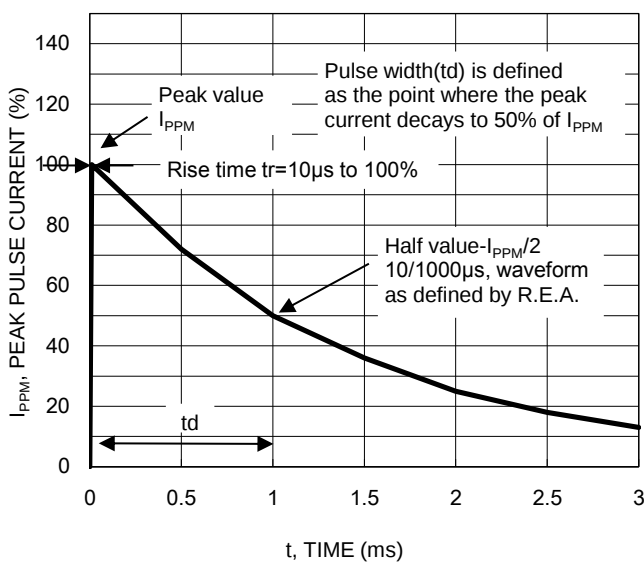
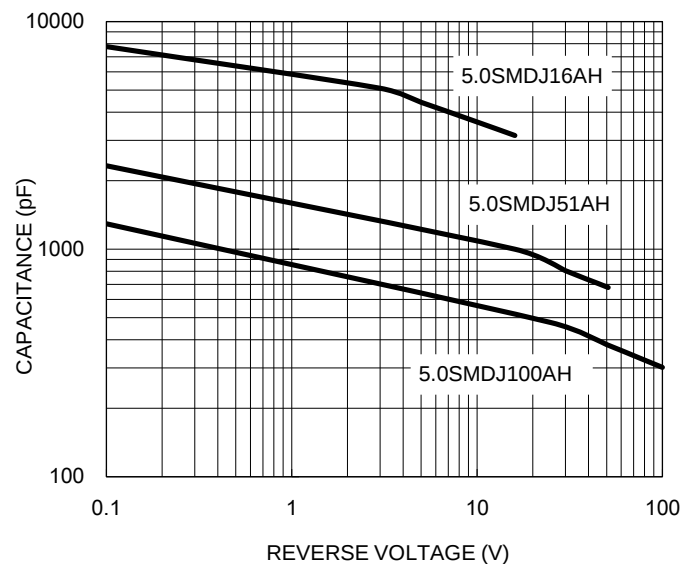
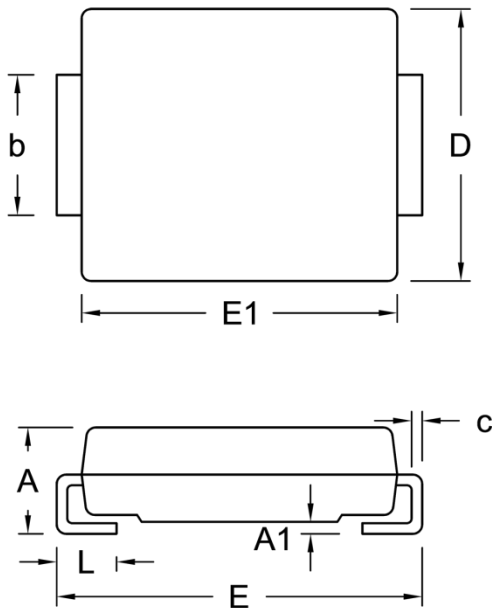


Fig.4 Typical Junction Capacitance



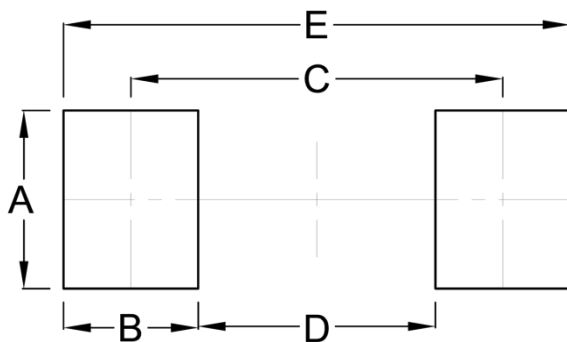
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.90	0.272
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



P/N = Marking Code
 G = Green Compound
 YW = Date Code
 F = Factory Code

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